



#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

## **Product Summary**

Device	BV <sub>DSS</sub>	RDS(ON) Max	ID MAX TA = +25°C
Q1	20V	$35m\Omega$ @ V <sub>GS</sub> = 4.5V	4.6A
N-Channel	N-Channel 200	43mΩ @ V <sub>GS</sub> = 2.5V	4.1A
Q2	201/	$75 \text{m}\Omega$ @ $V_{GS} = -4.5V$	-3.1A
P-Channel	-20V	110mΩ @ V <sub>GS</sub> = -2.5V	-2.6A

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, which makes it ideal for high-efficiency power management applications.

- Load Switch
- **Power Management Functions**
- Portable Power Adaptors

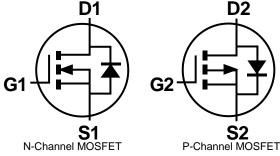
# **Features**

- PCB Footprint of 4mm<sup>2</sup>
- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Maximum Height
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

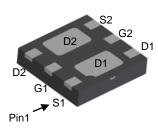
## **Mechanical Data**

- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e4)
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)



Internal Schematic

#### U-DFN2020-6 (Type B)



**Bottom View** 

### **Ordering Information** (Note 4)

Part Number	Case	Packaging				
DMC2053UFDB-7	U-DFN2020-6 (Type B)	3,000/Tape & Reel				
DMC2053UFDB-13	U-DFN2020-6 (Type B)	10,000/Tape & Reel				

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**



H4 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0 = 2020)

W = Week (ex: a = Week 27; z Represents Week 52 and 53)

X = Internal Code (ex: U = Monday)

Date Code Key

Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	9	0	1	2	3	4	5	6	7	8	9	0

Week	1-26	27-52	53		
Code	A-Z	a-z	Z		

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	X	Y	Z



## **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit		
Drain-Source Voltage	VDSS	20	-20	V		
Gate-Source Voltage	Vgss	±12	±12	V		
Continuous Drain Current (Note 6) N-Channel: V <sub>GS</sub> = 4.5V P-Channel: V <sub>GS</sub> = -4.5V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	lo	4.6 3.7	-3.1 -2.5	А
Maximum Continuous Body Diode Forward Cur	Is	1.1	-1.05	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I <sub>DM</sub>	24	-15	Α		

# **Thermal Characteristics**

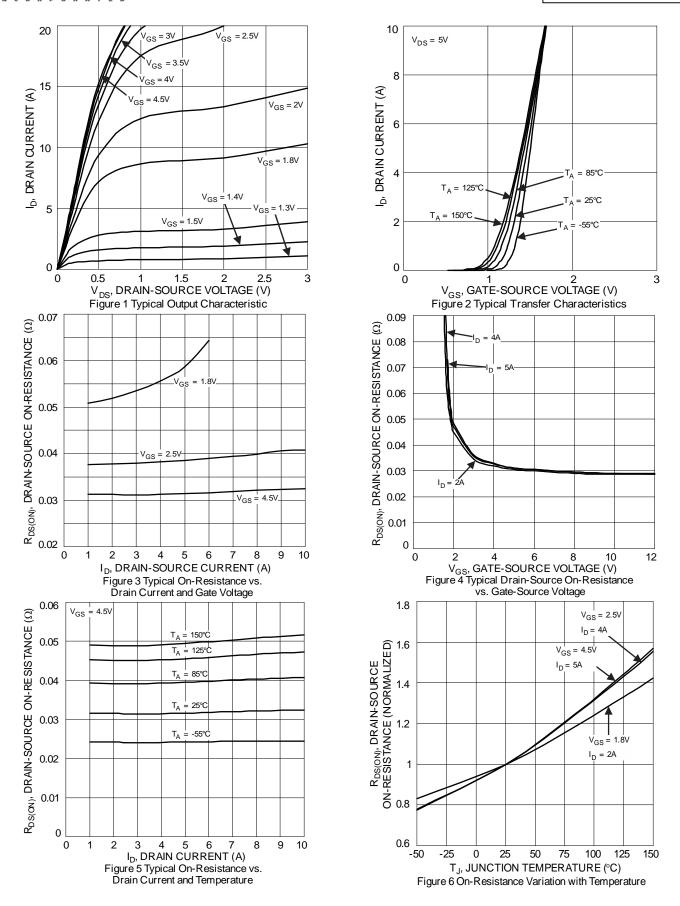
Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	0.82	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Rөja	153	°C/W
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	$P_D$	1.14	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Rөja	110	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C	

# Electrical Characteristics Q1 N-CHANNEL (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

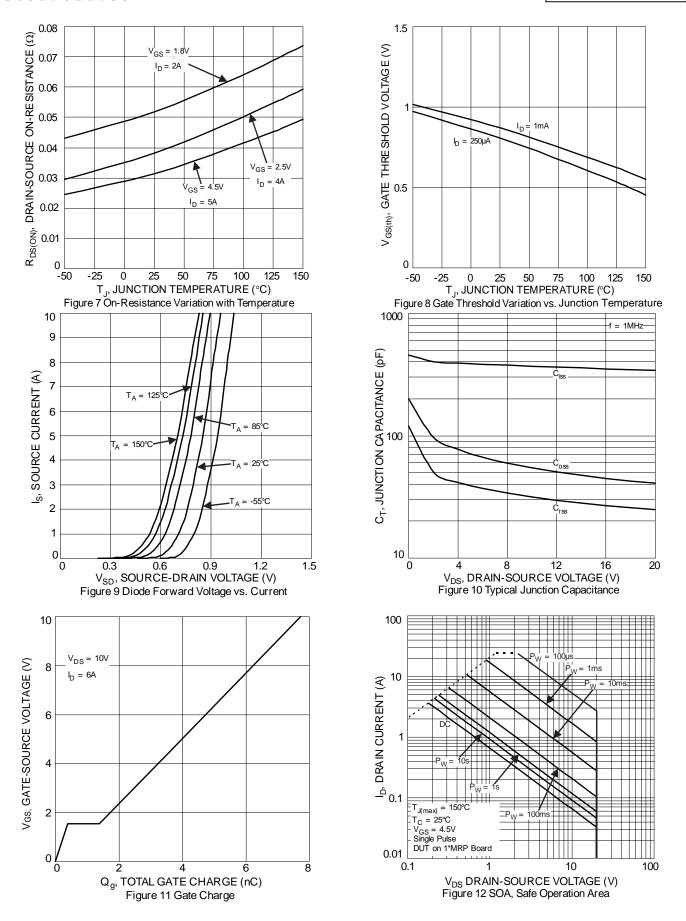
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition			
OFF CHARACTERISTICS (Note 7)									
Drain-Source Breakdown Voltage	$BV_{DSS}$	20	l	_	V	$V_{GS} = 0V, I_D = 250\mu A$			
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_	-	1.0	μΑ	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V			
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 12V$ , $V_{DS} = 0V$			
ON CHARACTERISTICS (Note 7)									
Gate Threshold Voltage	Vgs(TH)	0.4	1	1.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$			
			24	35		$V_{GS} = 4.5V, I_D = 5A$			
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)	_ [	30	43	mΩ	$V_{GS} = 2.5V, I_{D} = 4A$			
			44	56		$V_{GS} = 1.8V, I_{D} = 2A$			
Diode Forward Voltage	$V_{SD}$	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$			
DYNAMIC CHARACTERISTICS (Note 8)									
Input Capacitance	C <sub>iss</sub>	-	369	_					
Output Capacitance	Coss	_	54	_	pF	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz			
Reverse Transfer Capacitance	Crss	_	32	_					
Gate Resistance	Rg	_	4.1	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$			
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	3.6	_					
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	7.7	_	nC	\\ 40\\ I= 6A			
Gate-Source Charge	Qgs	_	0.4	_	IIC	$V_{DS} = 10V$ , $I_D = 6A$			
Gate-Drain Charge	$Q_{gd}$	_	1.0	_					
Turn-On Delay Time	t <sub>D</sub> (ON)	_	2.6	_					
Turn-On Rise Time	t <sub>R</sub>	_	3.0	_	20	$V_{DS} = 10V, V_{GS} = 4.5V,$			
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	12.5	_	ns	$R_g = 6\Omega$ , $R_L = 10\Omega$ , $I_D = 6A$			
Turn-Off Fall Time	tF	_	3.6	_					
Reverse Recovery Time	trr	_	6.0	_	ns	I <sub>F</sub> = 1A, di/dt = 100A/μs			
Reverse Recovery Charge	Q <sub>RR</sub>		0.9	_	nC	IF = 1A, di/dt = 100A/µs			

- 5. Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
  6. Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.

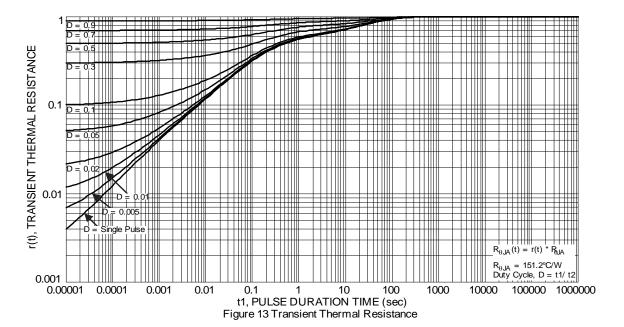














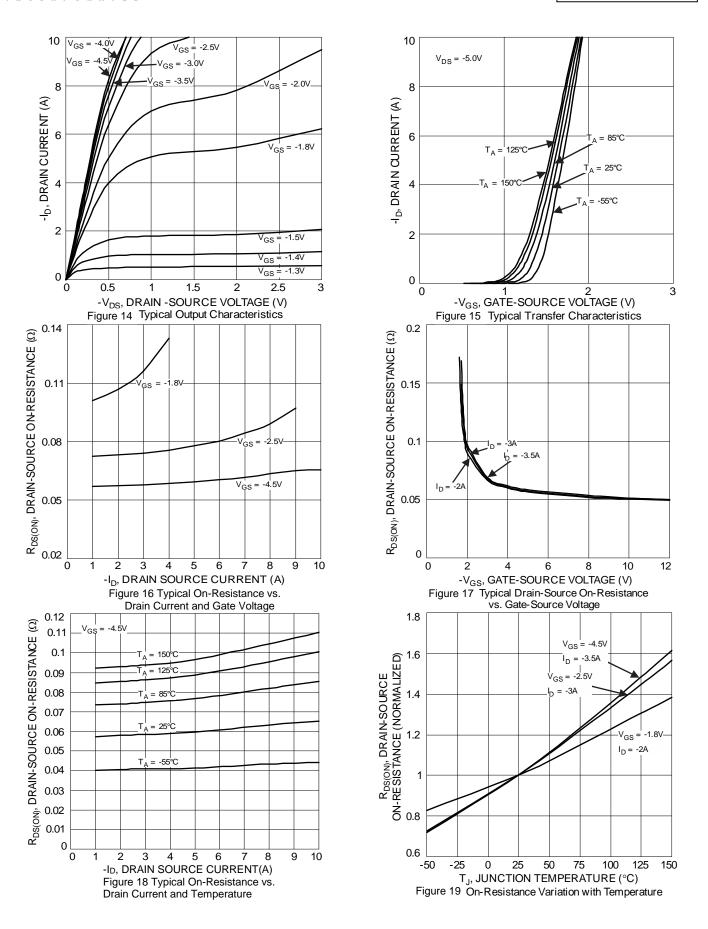
# Electrical Characteristics Q2 P-CHANNEL (@ TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 7)	-				I.	•		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_	_	V	V <sub>G</sub> S = 0V, I <sub>D</sub> = -250μA		
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	_	_	-1.0	μΑ	$V_{DS} = -20V, V_{GS} = 0V$		
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 12V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 7)								
Gate Threshold Voltage	Vgs(TH)	-0.45	_	-1.0	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$		
		_	57	75		V <sub>G</sub> S = -4.5V, I <sub>D</sub> = -3.5A		
Static Drain-Source On-Resistance	RDS(ON)	_	73	110	mΩ	V <sub>G</sub> S = -2.5V, I <sub>D</sub> = -3.0A		
		_	105	168		V <sub>G</sub> S = -1.8V, I <sub>D</sub> = -2.0A		
Diode Forward Voltage	VsD	_	-0.7	-1.2	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = -1.0A		
DYNAMIC CHARACTERISTICS (Note 8)					•			
Input Capacitance	Ciss	_	440	_	pF			
Output Capacitance	Coss	_	60	_	pF	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, f = 1.0MHz		
Reverse Transfer Capacitance	Crss	_	48	_	pF	1 – 1.001112		
Gate Resistance	Rg	_	8.5	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$		
Total Gate Charge (V <sub>GS</sub> = -4.5V)	0	_	5.9	_	nC			
Total Gate Charge (V <sub>GS</sub> = -8V)	$Q_g$	_	12.7	_	nC			
Gate-Source Charge	Q <sub>gs</sub>	_	0.6	_	nC	$V_{DS} = -4V$ , $I_{D} = -3.5A$		
Gate-Drain Charge	Qgd	_	2.1	_	nC			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.2	_	ns			
Turn-On Rise Time	t <sub>R</sub>	_	7.8	_	ns	$V_{DS} = -4V, V_{GS} = -4.5V,$		
Turn-Off Delay Time t <sub>D(OF</sub>		_	31	_	ns	$R_L = 4\Omega$ , $R_g = 6\Omega$		
Turn-Off Fall Time	tF	_	18	_	ns			
Body Diode Reverse Recovery Time	trr	_	10.5	_	ns	Is = -2.0A, dI/dt = 100A/µs		
Body Diode Reverse Recovery Charge	Qrr	_	3.0	_	nC	Is = -2.0A, dI/dt = 100A/µs		

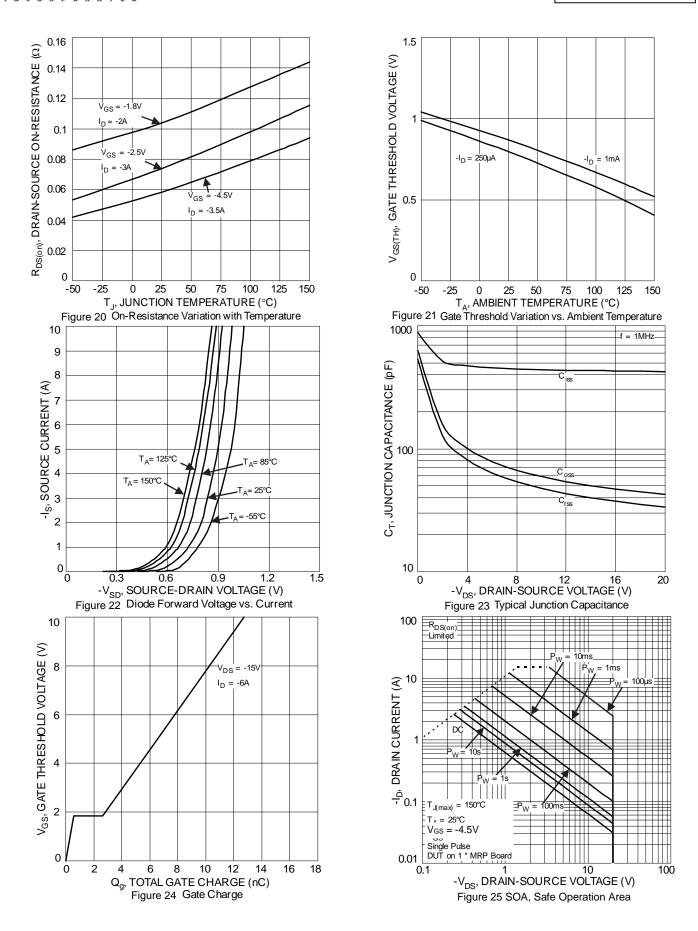
Notes:

<sup>7.</sup> Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.





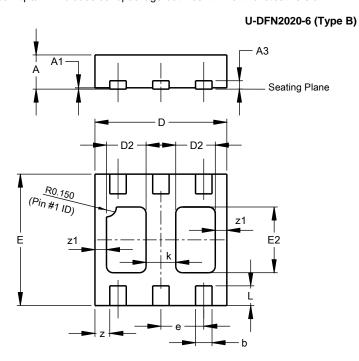






# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

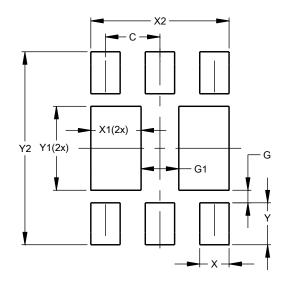


U-DFN2020-6 Type B									
Dim									
A	0.545	0.605	0.575						
A1	0.00	0.05	0.02						
A3	-	-	0.13						
b	0.20	0.30	0.25						
D	1.95	2.075	2.00						
D2	0.50	0.70	0.60						
е	-	-	0.65						
Е	1.95	2.075	2.00						
E2	0.90	1.10	1.00						
k	-	-	0.45						
L	0.25	0.35	0.30						
z	-	-	0.225						
z1	-	-	0.175						
All Dimensions in mm									

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### U-DFN2020-6 (Type B)



Dimensions	Value (in mm)				
С	, ,				
	0.650				
G	0.150				
G1	0.450				
Х	0.350				
X1	0.600				
X2	1.650				
Υ	0.500				
Y1	1.000				
Y2	2.300				



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